# End of Life - Replaced by BCM48Bx160y240A00





# **BCM<sup>®</sup> Bus Converter** B048F160T24 B048F160M24

# Narrow Input Range Sine Amplitude Converter™

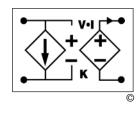
- 48 V to 16 V VI Chip<sup>®</sup> Bus Converter
- 240 Watt (360 Watt for 1 ms)
- High density 813 W/in<sup>3</sup>
- Small footprint 210 W/in<sup>2</sup>
- Low weight 0.5 oz (15 g)
- ZVS / ZCS isolated Sine Amplitude Converter™

## **Product Description**

The VI Chip<sup>®</sup> bus converter is a high efficiency (>95%), narrow input range Sine Amplitude Converter<sup>™</sup> (SAC<sup>™</sup>) operating from a 38 to 55 Vdc primary bus to deliver an isolated 12.7 V to 18.3 V secondary. The bus converter may be used to power non-isolated POL converters or as an independent 12.7 - 18.3 V source. Due to the fast response time and low noise of the bus converter, the need for limited life aluminum electrolytic or tantalum capacitors at the load is reduced—or eliminated resulting in savings of board area, materials and total system cost.

The bus converter achieves a power density of 813 W/in<sup>3</sup> in a VI Chip package compatible with standard pick-andplace and surface mount assembly process. The VI Chip package provides flexible thermal management through its low junction-to-board and junction-to-case thermal resistance. Owing to its high conversion efficiency and safe operating temperature range, the bus converter does not require a discrete heat sink in typical applications. Low junction-to-case and junction-to-lead thermal impedances assure low junction temperatures and long life in the harshest environments.

- Typical efficiency 95%
- 125°C operation (T<sub>J</sub>)
- <1 µs transient response
- 3.5 million hours MTBF
- No output filtering required
- V<sub>IN</sub> = 38 55 V Vout = 12.7 - 18.3 V **Ι**ουτ = **15 Α** K = 1/3  $R_{OUT} = 40 \text{ m}\Omega \text{ max}$



# **Absolute Maximum Ratings**

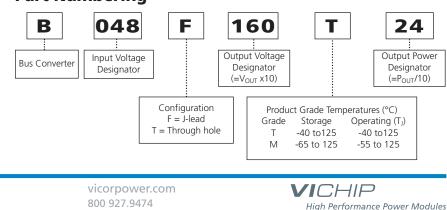
Parameter	Values	Unit	Notes
+In to -In -	-1.0 to 60	Vdc	
	100	Vdc	For 100 ms
PC to -In	-0.3 to 7.0	Vdc	
+Out to -Out	-0.5 to 25	Vdc	
Isolation voltage	2,250	Vdc	Input to output
Output current	20	А	Continuous
Peak output current	22.5	А	For 1 ms
Output power	240	W	Continuous
Peak output power	360	W	For 1 ms
Case temperature during reflow <sup>[a]</sup> -	225	°C	MSL 5
	245	°C	MSL 6, TOB = 4 hrs
Operating junction temperature <sup>[b]</sup>	-40 to 125	°C	T-Grade
Operating junction temperature	-55 to 125	°C	M-Grade
Storage temperature	-40 to 125	°C	T-Grade
	-65 to 125	°C	M-Grade

#### Notes:

[a] 245°C reflow capability applies to product with manufacturing date code 1001 and greater.

[b] The referenced junction is defined as the semiconductor having the highest temperature. This temperature is monitored by a shutdown comparator.

# **Part Numbering**



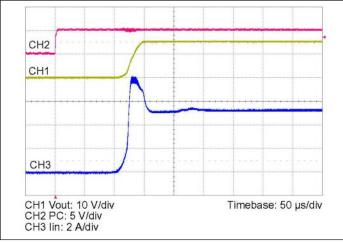
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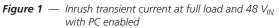
# **Specifications**

Input (Conditions are at 48  $V_{IN}$ , full load, and 25°C ambient unless otherwise specified)

Parameter	Min	Тур	Мах	Unit	Note
Input voltage range	38	48	55	Vdc	
Input dV/dt			1	V/µs	
Input undervoltage turn on			37.4	Vdc	
Input undervoltage turn off	32.0			Vdc	
Input overvoltage turn on	55.0			Vdc	
Input overvoltage turn off			60.0	Vdc	
Input quiescent current		2.6		mA	PC low
Inrush current overshoot		2.9		А	Using test circuit in Figure 20; See Figure 1
Input current			5.5	Adc	
Input reflected ripple current		138		mA p-p	Using test circuit in Figure 20; See Figure 4
No load power dissipation		4.9	6.5	W	
Internal input capacitance		4.0		μF	
Internal input inductance		5		nH	
Recommended external input capacitance		47		μF	200 nH maximum source inductance; See Figure 20

# **Input Waveforms**





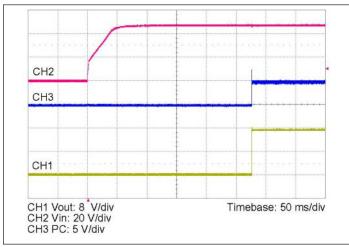
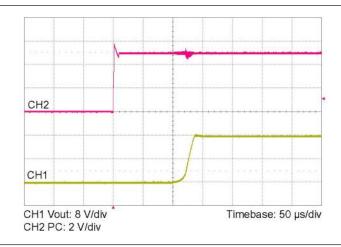
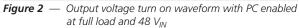
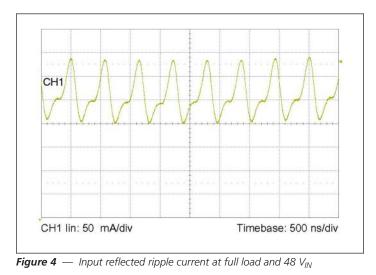


Figure 3 — Output voltage turn on waveform with input turn on at full load and 48  $V_{\rm IN}$ 









# Specifications (continued)

Output (Conditions are at 48 Vin, full load, and 25°C ambient unless otherwise specified)

	Parameter	Min	Тур	Max	Unit	Note
12.117.8VdcFull loadOutput power0240W38 - 55 V <sub>M</sub> .Rated DC current020Adc $P_{QUT} \le 240$ WPeak repetitive power360WMax pulse width 1ms, max duty cycle 10%, baseline power 50%.Current share accuracy510%See Parallel Operation on Page 10EfficiencyHalf load94.394.9%See Figure 5Half load94.594.8%See Figure 5Internal output inductance1.6nHinternal output capactanceLoad papatiance25.4 $\mu$ FEffective valueLoad capactance600 $\mu$ FOutput overvoltage set point18.3VdcModule will shut downOutput ipple voltage13.4mVp-pSee Figure 7 and 910 µF bypass capacitor13.4mVp-pSee Figure 8Short circuit protection set point20.0AdcModule will shut downAverage short circuit protection set point20.0AdcModule will shut downK0.33001/30.3367Vour = K v_M at no loadLoad regulation10.30.3367Vour = K v_M at no loadK0.33001/30.3367Vour = K v_M at no loadLoad regulation250mV100% load step; See Figures 10 and 11Recovery time1 $\mu$ psSee Figures 10 and 11Regores time200nsSee Figures 10 and 11Recovery time1 $\mu$ ssSee Figure 3 </td <td></td> <td>12.7</td> <td></td> <td>18.3</td> <td>Vdc</td> <td>No load</td>		12.7		18.3	Vdc	No load
Output power      0      237      W      38 - 55 V <sub>NL</sub> Rated DC current      0      20      Adc      Pours 240 W        Peak repetitive power      360      W      Max pulse width 1ms, max duty cycle 10%, baseline power 50%        Current share accuracy      5      10      %      See Parallel Operation on Page 10        Efficiency	Output voltage	12.1		17.8	Vdc	Full load
Internal Rated DC current0237W38 - 55 Vs. NetRated DC current020Adc $P_{Outr} \le 240$ WPeak repetitive power360WMax pulse width 1ms, max duty cycle 10%, baseline power 50%Current share accuracy510%See Parallel Operation on Page 10EfficiencyHalf Ioad94.394.9%See Figure 5Full load94.594.8%See Figure 5Internal output rapacitance1.6nHInternal output capacitanceLoad capacitance25.4 $\mu$ FEffective valueLoad capacitance600 $\mu$ FOutput vipple voltage st point18.3VdcModule will shut downOutput vipple voltage153300mVp-pSee Figure 5No external bypass153300mVp-pSee Figure 8Short circuit protection set point20.0AdcModule will shut downAverage short circuit current0.176AAEffective svitching frequency3.33.63.7MHzLine regulation $K$ 0.33001/30.3367Vour = K+V_N at no loadLoad caporse time200nsSee Figures 10 and 11Resores 10 and 11Recovery time1 $\mu$ See Figures 10 and 11Reco		0		240	W	38 - 55 V <sub>IN</sub>
InternationalImage: Constraint of the co		0		237	W	38 - 55 V <sub>IN</sub>
Peak repetitive power  300  W  baseline power 50%    Current share accuracy  5  10  %  See Parallel Operation on Page 10    Efficiency	Rated DC current	0		20	Adc	$P_{OUT} \le 240 \text{ W}$
baseline power 50%EfficiencyHalf load94.394.9%See Figure 5Full load94.594.8%See Figure 5Internal output inductance1.6nHInternal output capacitance25.4µFEffective valueLoad capacitance600µFOutput overvoltage set point18.3VdcModule will shut downOutput riple voltage153300mVp-pSee Figure 5No external bypass153300mVp-pSee Figure 8No external bypass153300mVp-pSee Figure 8Short circuit protection set point20.0AdcModule will shut downAverage short circuit current0.176AEffective switching frequencyK0.33001/30.3367Vour = K•V <sub>N</sub> at no loadLoad regulation29.740mQTransient responseK0.33001/30.3367Vour = K•V <sub>N</sub> at no loadLoad regulation250mV100% load step; See Figures 10 and 11Response time200nsSee Figures 10 and 11Response time200nsSee Figures 10 and 11Recovery time1µsSee Figure 10 and 11Output torroshoot0mVNo output filter; See Figure 3PC enable0mVNo output filter; See Figure 3PC enable0mVNo output filter; See Figure 3PC enable0mVNo output f	Poak ropotitivo powor			260	\\/	Max pulse width 1ms, max duty cycle 10%,
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$\begin{tabular}{ c c c c c } \hline Half load & 94.3 & 94.9 & \% & See Figure 5 \\ \hline Full load & 94.5 & 94.8 & \% & See Figure 5 \\ \hline Internal output inductance & 1.6 & nH & \\ \hline Internal output capacitance & 25.4 & \mu F & Effective value & \\ \hline Load capacitance & 600 & \mu F & \\ \hline Output overvoltage set point & 18.3 & Vdc & Module will shut down & \\ \hline Output ripple voltage & & \\ \hline No external bypass & 153 & 300 & mVp-p & See Figure 7 and 9 & \\ \hline 10 \ \mu F bypass capacitor & 13.4 & mVp-p & See Figure 8 & \\ \hline No external bypass & 0.176 & A & \\ \hline Effective switching frequency & 3.3 & 3.6 & 3.7 & MHz & Fixed, 1.8 \ MHz per phase & \\ \hline Load regulation & & & \\ \hline Rour & 29.7 & 40 & m\Omega & \\ \hline Transient response & & & \\ \hline Voltage overshoot & 250 & mV & 100\% \ load step; See Figures 10 and 11 & \\ \hline Reponse time & 200 & ns & See Figures 10 and 11 & \\ \hline Reponse time & 200 & ns & See Figures 10 and 11 & \\ \hline Reponse time & 200 & ns & See Figures 10 and 11 & \\ \hline Reponse time & 200 & ns & See Figures 10 and 11 & \\ \hline Reponse time & 200 & ns & See Figures 10 and 11 & \\ \hline Reponse time & 200 & ns & See Figures 10 and 11 & \\ \hline Reponse time & 0 & mV & No output filter; See Figure 3 & \\ \hline Output tore not & 0 & mV & No output filter; See Figure 3 & \\ \hline PC \ enable & 0 & mV & No output filter; See Figure 3 & \\ \hline Output turn on \ delay & & \\ \hline From application of power & 280 & ms & No output filter; See Figure 3 & \\ \hline \end{tabular}$	Current share accuracy		5	10	%	See Parallel Operation on Page 10
Full load94.594.8%See Figure 5Internal output inductance1.6nHInternal output capacitance25.4 $\mu$ FEffective valueLoad capacitance600 $\mu$ FOutput overvoltage set point18.3VdcModule will shut downOutput ripple voltage153300mVp-pSee Figures 7 and 910 $\mu$ F bypass capacitor13.4mVp-pSee Figures 8Short circuit protection set point20.0AdcModule will shut downAverage short circuit current0.176AEffective switching frequency3.33.63.7MHzK0.33001/30.3367Vout = K•V <sub>IN</sub> at no loadLoad regulation29.740mQRour29.740mQTransient response200nsSee Figures 10 and 11Output overshoot250mV100% load step; See Figures 10 and 11Output overshoot250mVNo output filter; See Figure 3Port overshoot200nsSee Figures 10 and 11Output overshoot1 $\mu$ sSee Figure 3PC enable0mVNo output filter; See Figure 3Output overshoot280msNo output filter; See Figure 3	Efficiency					
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Internal output capacitance      25.4      μF      Effective value        Load capacitance      600      μF        Output overvoltage set point      18.3      Vdc      Module will shut down        Output ripple voltage       Mo external bypass      153      300      mVp-p      See Figures 7 and 9        10 μF bypass capacitor      13.4      mVp-p      See Figures 7 and 9         Short circuit protection set point      20.0      Adc      Module will shut down        Average short circuit current      0.176      A         Effective switching frequency      3.3      3.6      3.7      MHz      Fixed, 1.8 MHz per phase        Line regulation        K      0.3300      1/3      0.3367      V <sub>OUT</sub> = K•V <sub>IN</sub> at no load        Load regulation         Fixed, 1.8 MHz per phase         Voltage overshoot      250      mV      100% load step; See Figures 10 and 11         Response time      200      ns      See Figures 10 and 11         Recovery time      1      µs      See Figures 10 and 11 <td>Full load</td> <td>94.5</td> <td>94.8</td> <td></td> <td>%</td> <td>See Figure 5</td>	Full load	94.5	94.8		%	See Figure 5
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Output overvoltage set point    18.3    Vdc    Module will shut down      Output ripple voltage    No external bypass    153    300    mVp-p    See Figures 7 and 9      10 µF bypass capacitor    13.4    mVp-p    See Figure 8      Short circuit protection set point    20.0    Adc    Module will shut down      Average short circuit protection set point    20.0    Adc    Module will shut down      Average short circuit protection set point    0.176    A    Effective switching frequency    3.3    3.6    3.7    MHz    Fixed, 1.8 MHz per phase      Line regulation    K    0.3300    1/3    0.3367    Vour = K•V <sub>IN</sub> at no load      Load regulation	Internal output capacitance		25.4		μF	Effective value
Output ripple voltage      No external bypass    153    300    mVp-p    See Figures 7 and 9      10 µF bypass capacitor    13.4    mVp-p    See Figure 8      Short circuit protection set point    20.0    Adc    Module will shut down      Average short circuit current    0.176    A      Effective switching frequency    3.3    3.6    3.7    MHz    Fixed, 1.8 MHz per phase      Line regulation            K    0.3300    1/3    0.3367    V <sub>OUT</sub> = K•V <sub>IN</sub> at no load       Load regulation            Rour    29.7    40    m2          Transient response	Load capacitance			600	μF	
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Transient response      Voltage overshoot    250    mV    100% load step; See Figures 10 and 11      Response time    200    ns    See Figures 10 and 11      Recovery time    1    µs    See Figures 10 and 11      Output overshoot    1    µs    See Figures 10 and 11      Output overshoot    0    mV    No output filter; See Figure 3      PC enable    0    mV    No output filter; See Figure 2      Output turn on delay    From application of power    280    ms    No output filter; See Figure 3	Load regulation					
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Output overshoot    0    mV    No output filter; See Figure 3      Input turn on    0    mV    No output filter; See Figure 3      PC enable    0    mV    No output filter; See Figure 2      Output turn on delay	Response time		200		ns	See Figures 10 and 11
Input turn on  0  mV  No output filter; See Figure 3    PC enable  0  mV  No output filter; See Figure 2    Output turn on delay	Recovery time		1		μs	See Figures 10 and 11
PC enable  0  mV  No output filter; See Figure 2    Output turn on delay	Output overshoot					
Output turn on delay  The output filter; See Figure 3	Input turn on		0		mV	No output filter; See Figure 3
From application of power 280 ms No output filter; See Figure 3	PC enable		0		mV	No output filter; See Figure 2
	Output turn on delay					
	From application of power		280		ms	No output filter; See Figure 3
			67		ms	No output filter

# **Output Waveforms**

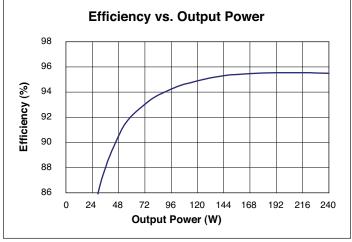


Figure 5 — Efficiency vs. output power

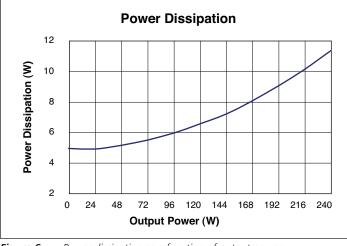
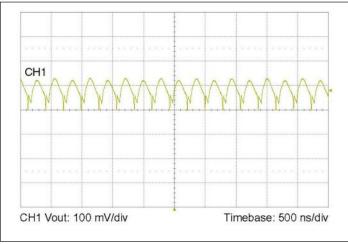


Figure 6 — Power dissipation as a function of output power

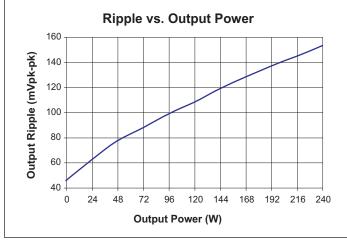


## Specifications (continued)

## **Output Waveforms**



 $\begin{array}{l} \textit{Figure 7} & - & \textit{Output voltage ripple at full load and 48 } V_{\textit{IN}} \\ & \textit{without any external bypass capacitor.} \end{array}$ 



**Figure 9** — Output voltage ripple vs. output power at  $48 V_{IN}$  without any external bypass capacitor.

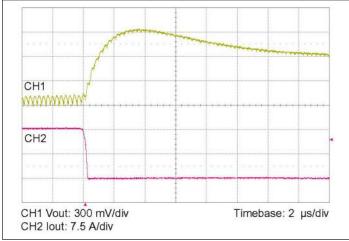
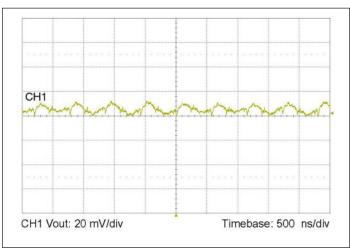
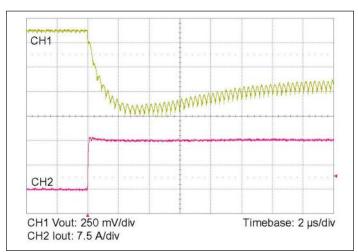


Figure 11 - 15 – 0 A load step with 100  $\mu$ F input capacitor and no output capacitor.



**Figure 8** — Output voltage ripple at full load and 48 V<sub>IN</sub> with 10 μF ceramic external bypass capacitor and 20 nH of distribution inductance.



**Figure 10** — 0 – 15 A load step with 100 µF input capacitor and no output capacitor.





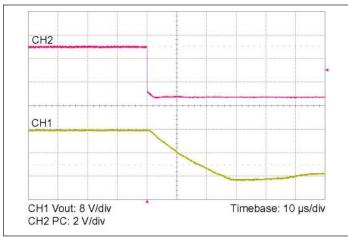
# Specifications (continued)

# General

Parameter	Min	Тур	Max	Unit	Note
MTBF					
MIL-HDBK-217F		3.5		Mhrs	25°C, GB
Isolation specifications					
Voltage	2,250			Vdc	Input to output
Capacitance		3,000		pF	Input to output
Resistance	10			MΩ	Input to output
		cTÜVus			UL/CSA 60950-1, EN 60950-1
Agency approvals		CE Marked	for Low Volt	tage Directive	and RoHS Recast Directive, as applicable
Mechanical					See mechanical drawings, Figures 15 – 18
Weight		0.53/15		oz/g	
Dimensions					
Length		1.28/32,5		in/mm	
Width		0.87/22		in/mm	
Height		0.265/6,73		in/mm	
Thermal					
Overtemperature shutdown	125	130	135	°C	Junction temperature
Thermal capacity		9.3		Ws/°C	
Junction-to-case thermal impedance $(R_{\theta JC})$		1.1		°C/W	See Thermal Considerations on Page 10
Junction-to-board thermal impedance (R <sub>0JB</sub> )		2.1		°C/W	

Auxiliary Pins (Conditions are at 48 Vin, full load, and 25°C ambient unless otherwise specified)

arameter	Min	Тур	Мах	Unit	Note
imary control (PC)					
DC voltage	4.8	5.0	5.2	Vdc	
Module disable voltage	2.4	2.5		Vdc	
Module enable voltage		2.5	2.6	Vdc	
Current limit	2.4	2.5	2.9	mA	Source only
Enable delay time		67		ms	
Disable delay time		30		μs	See Figure 12, time from PC low to output low



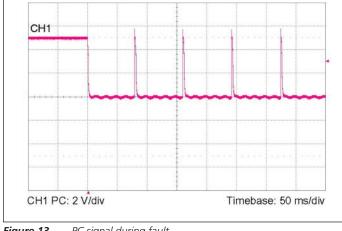
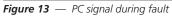


Figure 12 — V<sub>OUT</sub> at full load vs. PC disable





# **Pin / Control Functions**

#### +In / -In – DC Voltage Input Ports

The VI Chip module input voltage range should not be exceeded. An internal undervoltage/overvoltage lockout function prevents operation outside of the normal operating input range. The BCM<sup>®</sup> bus converter turns on within an input voltage window bounded by the "Input undervoltage turn on" and "Input overvoltage turn off" levels, as specified. The module may be protected against accidental application of a reverse input voltage by the addition of a rectifier in series with the positive input, or a reverse rectifier in shunt with the positive input located on the load side of the input fuse.

The connection of the module to its power source should be implemented with minimal distribution inductance. If the interconnect inductance exceeds 100 nH, the input should be bypassed with a RC damper to retain low source impedance and stable operation. With an interconnect inductance of 200 nH, the RC damper may be 47  $\mu$ F in series with 0.3 $\Omega$ . A single electrolytic or equivalent low-Q capacitor may be used in place of the series RC bypass.

#### PC – Primary Control

The Primary Control port is a multifunction node that provides the following functions:

Enable / Disable – If the PC port is left floating, the BCM module output is enabled. Once this port is pulled lower than 2.4 Vdc with respect to –In, the output is disabled. This action can be realized by employing a relay, opto-coupler, or open collector transistor. Refer to Figures 1-3, 12 and 13 for the typical enable/disable characteristics. This port should not be toggled at a rate higher than 1 Hz. The PC port should also not be driven by or pulled up to an external voltage source.

<u>Primary Auxiliary Supply</u> – The PC port can source up to 2.4 mA at 5.0 Vdc. The PC port should never be used to sink current.

<u>Alarm</u> – The module contains circuitry that monitors output overload, input overvoltage or undervoltage, and internal junction temperatures. In response to an abnormal condition in any of the monitored parameters, the PC port will toggle. Refer to Figure 13 for PC alarm characteristics.

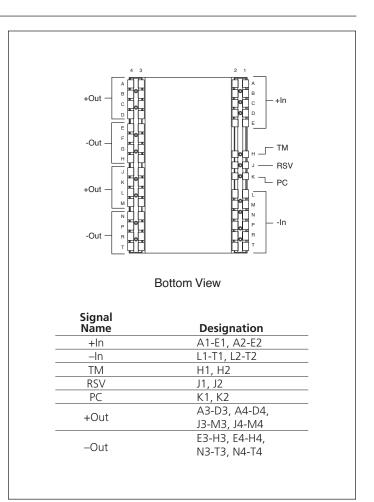
#### TM and RSV – Reserved for factory use.

#### +Out / -Out – DC Voltage Output Ports

Two sets of contacts are provided for the +Out port. They must be connected in parallel with low interconnect resistance. Similarly, two sets of contacts are provided for the –Out port. They must be connected in parallel with low interconnect resistance. Within the specified operating range, the average output voltage is defined by the Level 1 DC behavioral model of Figure 21. The current source capability of the module is rated in the specifications section of this document.

The low output impedance of the module reduces or eliminates the need for limited life aluminum electrolytic or tantalum capacitors at the input of POL converters.

Total load capacitance at the output of the modules should not exceed the specified maximum. Owing to the wide bandwidth and low output impedance of the module, low frequency bypass capacitance and significant energy storage may be more densely and efficiently provided by adding capacitance at the input of the BCM module.







## **Mechanical Drawings**

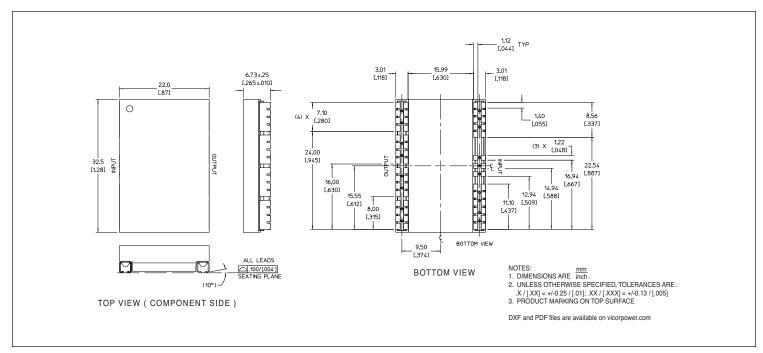


Figure 15 — BCM<sup>®</sup> module J-Lead mechanical outline; onboard mounting

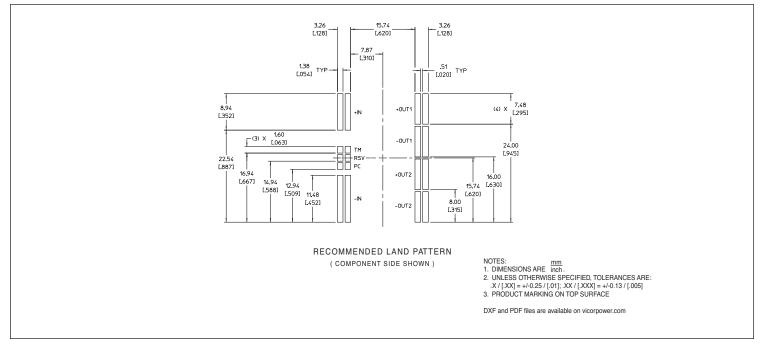


Figure 16 — BCM module PCB land layout information



# End of Life - Replaced by BCM48Bx160y240A00

# B048F160T24

### Mechanical Drawings (continued)

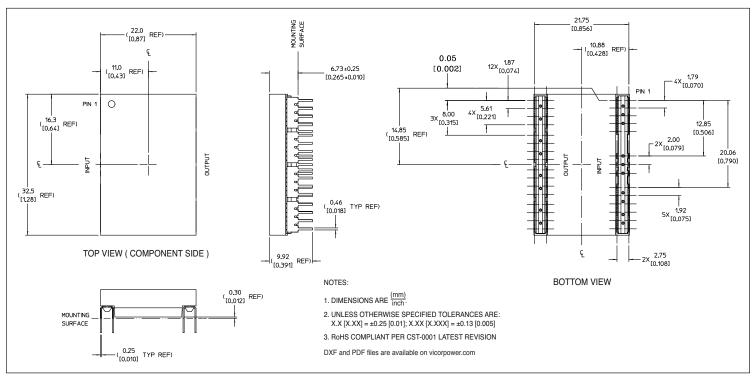
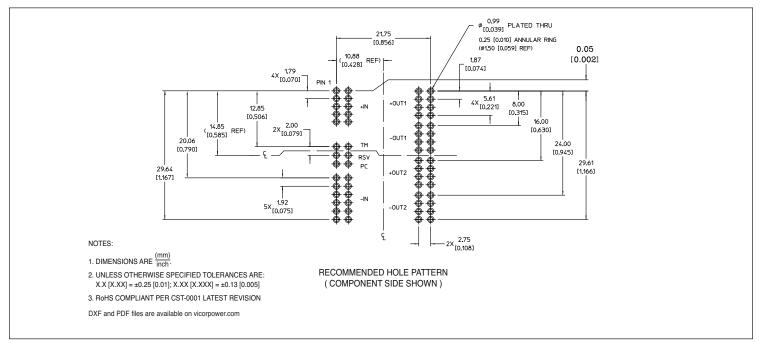


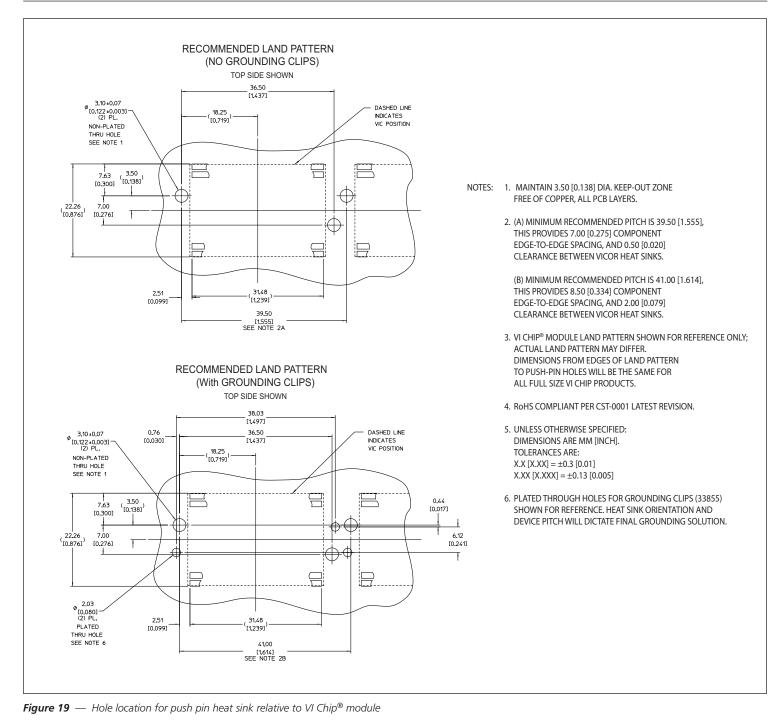
Figure 17 — BCM<sup>®</sup> through-hole module mechanical outline







# **Configuration Options**





# **Application Note**

#### **Parallel Operation**

The BCM<sup>®</sup> bus converter will inherently current share when operated in an array. Arrays may be used for higher power or redundancy in an application.

Current sharing accuracy is maximized when the source and load impedance presented to each bus converter within an array are equal. The recommended method to achieve matched impedances is to dedicate common copper planes within the PCB to deliver and return the current to the array, rather than rely upon traces of varying lengths. In typical applications the current being delivered to the load is larger than that sourced from the input, allowing traces to be utilized on the input side if necessary. The use of dedicated power planes is, however, preferable.

The bus converter power train and control architecture allow bidirectional power transfer, including reverse power processing from the module output to its input. Reverse power transfer is enabled if the module input is within its operating range and the module is otherwise enabled. The bus converter's ability to process power in reverse improves the module's transient response to an output load dump.

#### **Thermal Considerations**

VI Chip products are multi-chip modules whose temperature distribution varies greatly for each part number as well as with the input/output conditions, thermal management and environmental conditions. Maintaining the top of the B048F160T24 case to less than 100°C will keep all junctions within the module below 125°C for most applications. The percent of total heat dissipated through the top surface versus through the J-lead is entirely dependent on the particular mechanical and thermal environment. The heat dissipated through the top surface is typically 60%. The heat dissipated through the J-lead onto the PCB board surface is typically 40%. Use 100% top surface dissipation when designing for a conservative cooling solution. It is not recommended to use a module for an extended period of time at full load without proper heat sinking.

#### Input Impedance Recommendations

To take full advantage of the BCM bus converter capabilities, the impedance presented to its input terminals must be low from DC to approximately 5 MHz. The source should exhibit low inductance and should have a critically damped response. If the interconnect inductance is excessive, the module input pins should be bypassed with an RC damper (e.g., 47  $\mu$ F in series with 0.3 ohm) to retain low source impedance and proper operation. Given the wide bandwidth of the module, the source response is generally the limiting factor in the overall system response.

Anomalies in the response of the source will appear at the output of the module multiplied by its K factor. The DC resistance of the source should be kept as low as possible to minimize voltage deviations. This is especially important if the module is operated near low or high line as the overvoltage/undervoltage detection circuitry could be activated.

#### Input Fuse Recommendations

VI Chip modules are not internally fused in order to provide flexibility in configuring power systems. However, input line fusing of the modules must always be incorporated within the power system. A fast acting fuse should be placed in series with the +In port.



#### Application Note (continued)

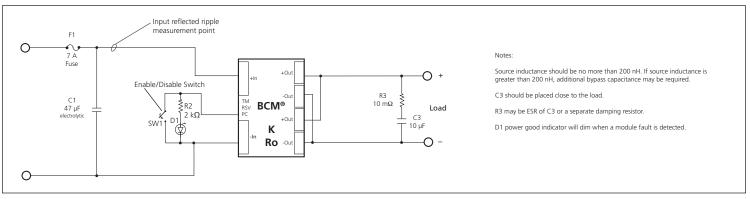
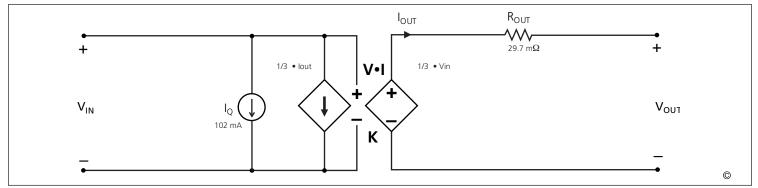


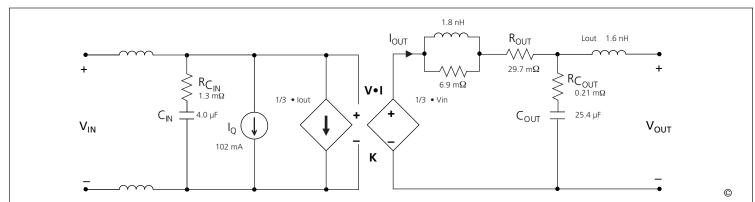
Figure 20 — BCM<sup>®</sup> module test circuit

#### BCM<sup>®</sup> Bus Converter Level 1 DC Behavioral Model for 48 V to 16 V, 240 W



**Figure 21** — This model characterizes the DC operation of the bus converter, including the converter transfer function and its losses. The model enables estimates or simulations of output voltage as a function of input voltage and output load, as well as total converter power dissipation or heat generation.

### BCM® Bus Converter Level 2 Transient Behavioral Model for 48 V to 16 V, 240 W



**Figure 22** — This model characterizes the AC operation of the bus converter including response to output load or input voltage transients or steady state modulations. The model enables estimates or simulations of input and output voltages under transient conditions, including response to a stepped load with or without external filtering elements.

BCM<sup>®</sup> Bus Converter Page 11 of 12

**Rev 3.0** 01/2014



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